

DATA SHEET

74ABT646A

Octal bus transceiver/register (3-State)

Product specification
Supersedes data of 1995 Sep 06
IC23 Data Handbook

1998 Feb 17

Octal bus transceiver/register (3-State)

74ABT646A

FEATURES

- Combines 74ABT245 and 74ABT374 type functions in one device
- Independent registers for A and B buses
- Live insertion/extraction permitted
- Power-up 3-State
- Power-up reset
- Multiplexed real-time and stored data
- Output capability: +64mA/–32mA
- Latch-up protection exceeds 500mA per Jedec Std 17
- ESD protection exceeds 2000 V per MIL STD 883 Method 3015 and 200 V per Machine Model

DESCRIPTION

The 74ABT646A high-performance BiCMOS device combines low static and dynamic power dissipation with high speed and high output drive.

The 74ABT646A transceiver/register consists of bus transceiver circuits with 3-State outputs, D-type flip-flops, and control circuitry arranged for multiplexed transmission of data directly from the input bus or the internal registers. Data on the A or B bus will be clocked into the registers as the appropriate clock pin goes High. Output Enable ($\overline{OE}$) and DIR pins are provided to control the transceiver function. In the transceiver mode, data present at the high impedance port may be stored in either the A or B register or both.

The Select (SAB, SBA) pins determine whether data is stored or transferred through the device in real-time. The DIR determines which bus will receive data when the $\overline{OE}$ is active (Low). In the isolation mode ($\overline{OE}$ = High), data from Bus A may be stored in the B register and/or data from Bus B may be stored in the A register. When an output function is disabled, the input function is still enabled and may be used to store and transmit data. Only one of the two buses, A or B, may be driven at a time. The examples on the next page demonstrate the four fundamental bus management functions that can be performed with the 74ABT646A.

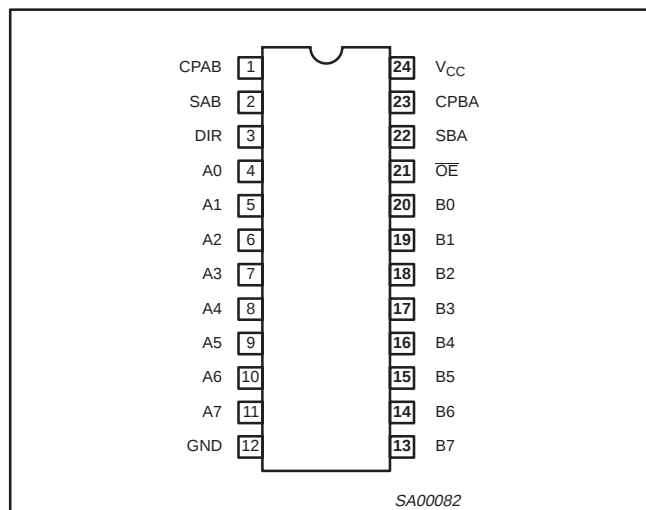
QUICK REFERENCE DATA

SYMBOL	PARAMETER	CONDITIONS $T_{amb} = 25^{\circ}\text{C}$; GND = 0V	TYPICAL	UNIT
t_{PLH} t_{PHL}	Propagation delay An to Bn or Bn to An	$C_L = 50\text{pF}$; $V_{CC} = 5\text{V}$	3.2 3.7	ns
C_{IN}	Input capacitance CP, S, $\overline{OE}$, DIR	$V_I = 0\text{V}$ or V_{CC}	4	pF
$C_{I/O}$	I/O capacitance	Outputs disabled; $V_O = 0\text{V}$ or V_{CC}	7	pF
I_{CCZ}	Total supply current	Outputs disabled; $V_{CC} = 5.5\text{V}$	110	μA

ORDERING INFORMATION

PACKAGES	TEMPERATURE RANGE	OUTSIDE NORTH AMERICA	NORTH AMERICA	DWG NUMBER
24-Pin Plastic DIP	–40°C to +85°C	74ABT646A N	74ABT646A N	SOT222-1
24-Pin plastic SO	–40°C to +85°C	74ABT646A D	74ABT646A D	SOT137-1
24-Pin Plastic SSOP Type II	–40°C to +85°C	74ABT646A DB	74ABT646A DB	SOT340-1
24-Pin Plastic TSSOP Type I	–40°C to +85°C	74ABT646A PW	74ABT646A PW	SOT355-1

PIN CONFIGURATION



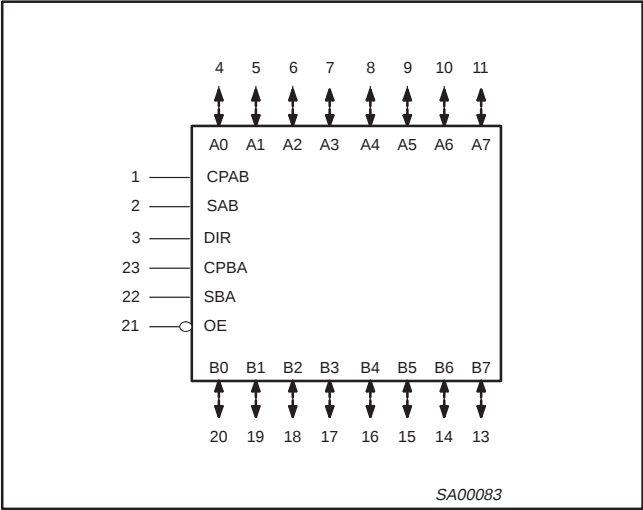
PIN DESCRIPTION

PIN NUMBER	SYMBOL	FUNCTION
1, 23	CPAB / CPBA	A to B clock input / B to A clock input
2, 22	SAB / SBA	A to B select input / B to A select input
3	DIR	Direction control input
4, 5, 6, 7, 8, 9, 10, 11	A0 – A7	Data inputs/outputs (A side)
20, 19, 18, 17, 16, 15, 14, 13	B0 – B7	Data inputs/outputs (B side)
21	$\overline{OE}$	Output enable input (active-Low)
12	GND	Ground (0V)
24	V_{CC}	Positive supply voltage

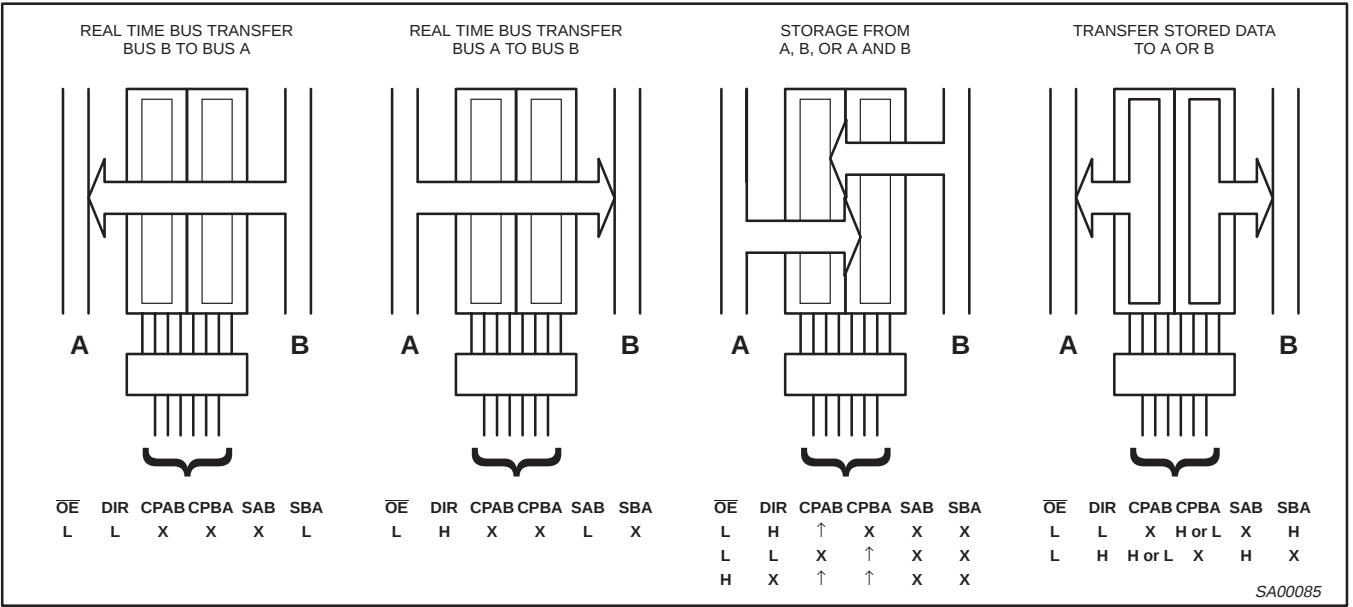
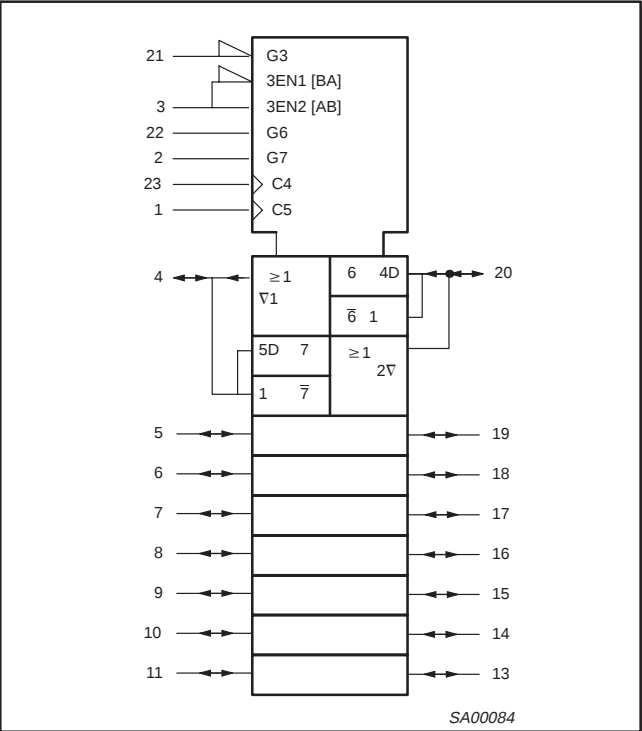
Octal bus transceiver/register (3-State)

74ABT646A

LOGIC SYMBOL



LOGIC SYMBOL (IEEE/IEC)



Octal bus transceiver/register (3-State)

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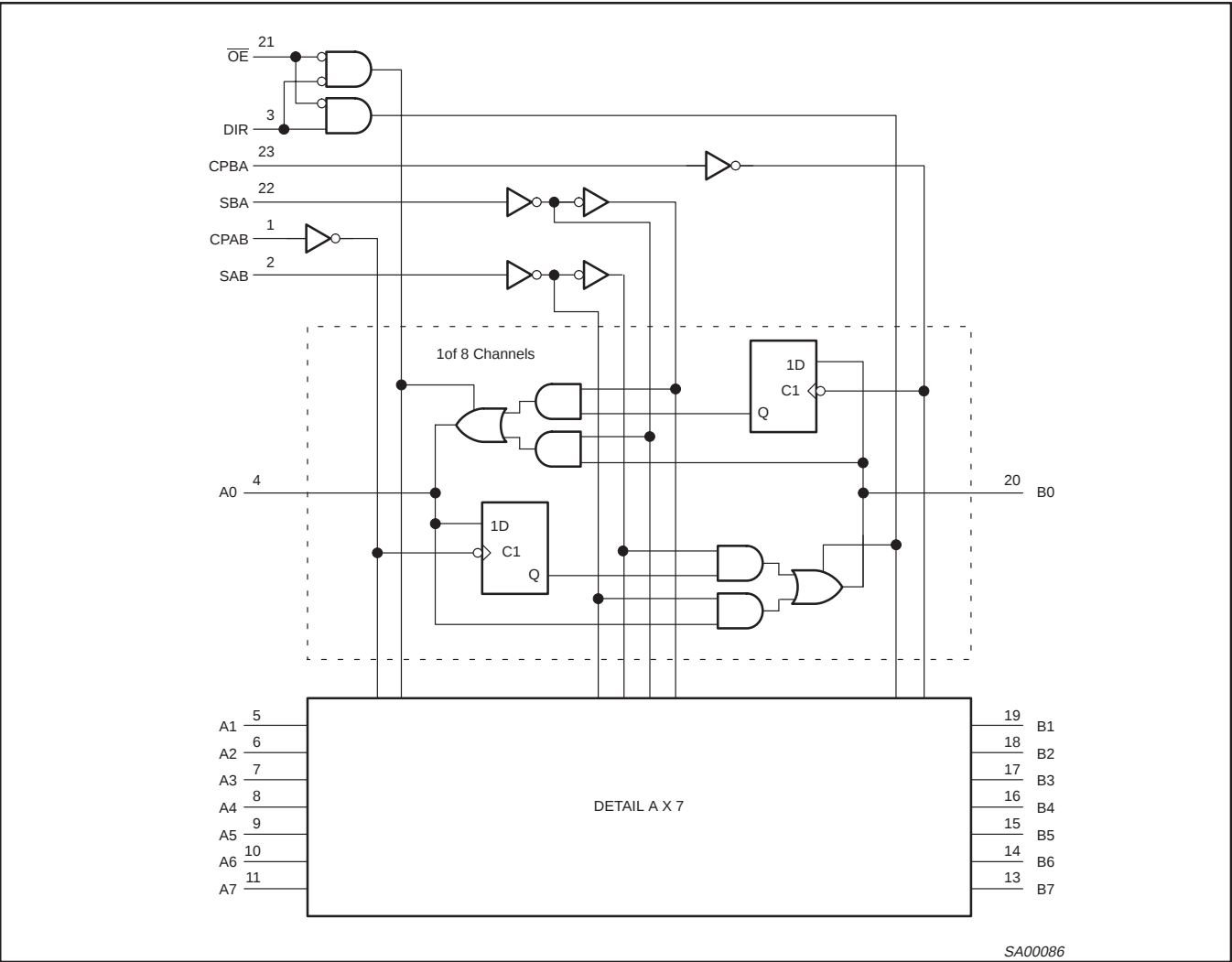
FUNCTION TABLE

INPUTS						DATA I/O		OPERATING MODE
OE	DIR	CPAB	CPBA	SAB	SBA	An	Bn	
X	X	↑	X	X	X	Input	Unspecified output*	Store A, B unspecified
X	X	X	↑	X	X	Unspecified output*	Input	Store B, A unspecified
H H	X X	↑ H or L	↑ H or L	X X	X X	Input	Input	Store A and B data Isolation, hold storage
L L	L L	X X	X H or L	X X	L H	Output	Input	Real time B data to A bus Stored B data to A bus
L L	H H	X H or L	X X	L H	X X	Input	Output	Real time A data to B bus Stored A data to B bus

H = High voltage level
L = Low voltage level
X = Don't care
↑ = Low-to-High clock transition

* The data output function may be enabled or disabled by various signals at the OE input. Data input functions are always enabled, i.e., data at the bus pins will be stored on every Low-to-High transition of the clock.

LOGIC DIAGRAM



Octal bus transceiver/register (3-State)

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ABSOLUTE MAXIMUM RATINGS^{1, 2}

SYMBOL	PARAMETER	CONDITIONS	RATING	UNIT
V_{CC}	DC supply voltage		−0.5 to +7.0	V
I_{IK}	DC input diode current	$V_I < 0$	−18	mA
V_I	DC input voltage ³		−1.2 to +7.0	V
I_{OK}	DC output diode current	$V_O < 0$	−50	mA
V_{OUT}	DC output voltage ³	output in Off or High state	−0.5 to +5.5	V
I_{OUT}	DC output current	output in Low state	128	mA
T_{Stg}	Storage temperature range		−65 to 150	°C

NOTES:

1. Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
2. The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction temperatures which are detrimental to reliability. The maximum junction temperature of this integrated circuit should not exceed 150°C.
3. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER	LIMITS		UNIT
		Min	Max	
V_{CC}	DC supply voltage	4.5	5.5	V
V_I	Input voltage	0	V_{CC}	V
V_{IH}	High-level input voltage	2.0		V
V_{IL}	Low-level Input voltage		0.8	V
I_{OH}	High-level output current		−32	mA
I_{OL}	Low-level output current		64	mA
$\Delta t/\Delta v$	Input transition rise or fall rate	0	10	ns/V
T_{amb}	Operating free-air temperature range	−40	+85	°C

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DC ELECTRICAL CHARACTERISTICS

SYMBOL	PARAMETER		TEST CONDITIONS	LIMITS					UNIT
				T _{amb} = +25°C			T _{amb} = -40°C to +85°C		
				Min	Typ	Max	Min	Max	
V _{IK}	Input clamp voltage		V _{CC} = 4.5V; I _{IK} = -18mA		-0.9	-1.2		-1.2	V
V _{OH}	High-level output voltage		V _{CC} = 4.5V; I _{OH} = -3mA; V _I = V _{IL} or V _{IH}	2.5	3.0		2.5		V
			V _{CC} = 5.0V; I _{OH} = -3mA; V _I = V _{IL} or V _{IH}	3.0	3.5		3.0		V
			V _{CC} = 4.5V; I _{OH} = -32mA; V _I = V _{IL} or V _{IH}	2.0	2.4		2.0		V
V _{OL}	Low-level output voltage		V _{CC} = 4.5V; I _{OL} = 64mA; V _I = V _{IL} or V _{IH}		0.3	0.55		0.55	V
V _{RST}	Power-up output low voltage ³		V _{CC} = 5.5V; I _O = 1mA; V _I = GND or V _{CC}		0.13	0.55		0.55	V
I _I	Input leakage current	Control pins	V _{CC} = 5.5V; V _I = GND or 5.5V		±0.01	±1.0		±1.0	μA
		Data pins	V _{CC} = 5.5V; V _I = GND or 5.5V		±5	±100		±100	μA
I _{OFF}	Power-off leakage current		V _{CC} = 0.0V; V _O or V _I ≤ 4.5V		±5.0	±100		±100	μA
I _{PU} /I _{PD}	Power-up/down 3-State output current ⁴		V _{CC} = 2.1V; V _O = 0.5V; V _I = GND or V _{CC} ; V _{OE} = Don't care		±5.0	±50		±50	μA
I _{IH} + I _{OZH}	3-State output High current		V _{CC} = 5.5V; V _O = 2.7V; V _I = V _{IL} or V _{IH}		5.0	50		50	μA
I _{IL} + I _{OZL}	3-State output Low current		V _{CC} = 5.5V; V _O = 0.5V; V _I = V _{IL} or V _{IH}		-5.0	-50		-50	μA
I _{CEX}	Output High leakage current		V _{CC} = 5.5V; V _O = 5.5V; V _I = GND or V _{CC}		5.0	50		50	μA
I _O	Output current ^{1, 5}		V _{CC} = 5.5V; V _O = 2.5V	-40	-65	-180	-40	-180	mA
I _{CCH}	Quiescent supply current		V _{CC} = 5.5V; Outputs High, V _I = GND or V _{CC}		110	250		250	μA
I _{CCL}				20	30		30	mA	
I _{CCZ}				110	250		250	μA	
ΔI _{CC}	Additional supply current per input pin ²		V _{CC} = 5.5V; one input at 3.4V, other inputs at V _{CC} or GND; V _{CC} = 5.5V		0.6	1.5		1.5	mA

NOTES:

1. Not more than one output should be tested at a time, and the duration of the test should not exceed one second.
2. This is the increase in supply current for each input at 3.4V.
3. For valid test results, data must not be loaded into the flip-flops (or latches) after applying the power.
4. This parameter is valid for any V_{CC} between 0V and 2.1V, with a transition time of up to 10msec. From V_{CC} = 2.1V to V_{CC} = 5V ± 10%, a transition time of up to 100µsec is permitted.
5. This data sheet limit may vary among suppliers.

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AC CHARACTERISTICS

GND = 0V, $t_R = t_F = 2.5\text{ns}$, $C_L = 50\text{pF}$, $R_L = 500\Omega$

SYMBOL	PARAMETER	WAVEFORM	LIMITS					UNIT
			T _{amb} = +25°C V _{CC} = +5.0V			T _{amb} = -40 to +85°C V _{CC} = +5.0V ±0.5V		
			Min	Typ	Max	Min	Max	
f _{MAX}	Maximum clock frequency	1	125	350		125		MHz
t _{PLH} t _{PHL}	Propagation delay CPAB to Bn or CPBA to An	1	2.2 1.7	3.9 4.4	5.1 5.2 ¹	2.2 1.7	5.6 5.6	ns
t _{PLH} t _{PHL}	Propagation delay An to Bn or Bn to An	2	1.5 1.5	3.2 3.7	4.3 4.6	1.5 1.5	4.8 5.4	ns
t _{PLH} t _{PHL}	Propagation delay SAB to Bn or SBA to An	2 3	1.5 1.5	3.8 4.4	5.1 5.3 ¹	1.5 1.5	6.5 5.9	ns
t _{PZH} t _{PZL}	Output enable time OE to An or Bn	5 6	1.5 3.0	3.5 4.5	5.3 7.4	1.5 3.0	6.3 8.8	ns
t _{PHZ} ¹ t _{PLZ}	Output disable time OE to An or Bn	5 6	1.5 1.5	4.0 3.3	4.8 ¹ 4.0	1.5 1.5	5.3 ¹ 4.5	ns
t _{PZH} t _{PZL}	Output enable time DIR to An or Bn	5 6	1.5 2.5	3.9 4.7	5.7 9.0	1.2 2.5	6.7 9.5	ns
t _{PHZ} t _{PLZ}	Output disable time DIR to An or Bn	5 6	1.5 1.5	4.0 3.5	5.0 4.7	1.5 1.5	5.7 6.0	ns

1. This data sheet limit may vary among suppliers.

AC SETUP REQUIREMENTS

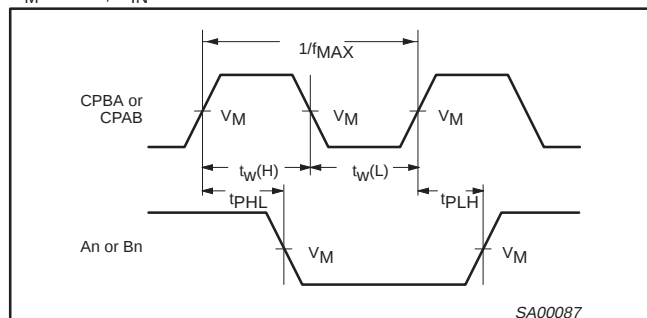
GND = 0V, $t_R = t_F = 2.5\text{ns}$, $C_L = 50\text{pF}$, $R_L = 500\Omega$

SYMBOL	PARAMETER	WAVEFORM	LIMITS			UNIT
			$T_{\text{amb}} = +25^\circ\text{C}$ $V_{\text{CC}} = +5.0\text{V}$		$T_{\text{amb}} = -40 \text{ to } +85^\circ\text{C}$ $V_{\text{CC}} = +5.0\text{V} \pm 0.5\text{V}$	
			Min	Typ	Min	
$t_s(\text{H})$ $t_s(\text{L})$	Setup time An to CPAB, Bn to CPBA	4	3.0 3.0	0.7 0.7	3.0 3.0	ns
$t_h(\text{H})$ $t_h(\text{L})$	Hold time An to CPAB, Bn to CPBA	4	0.0 0.0	-0.5 -0.5	0.0 0.0	ns
$t_w(\text{H})$ $t_w(\text{L})$	Pulse width, High or Low CPAB or CPBA	1	4.0 4.0	0.9 1.4	4.0 4.0	ns

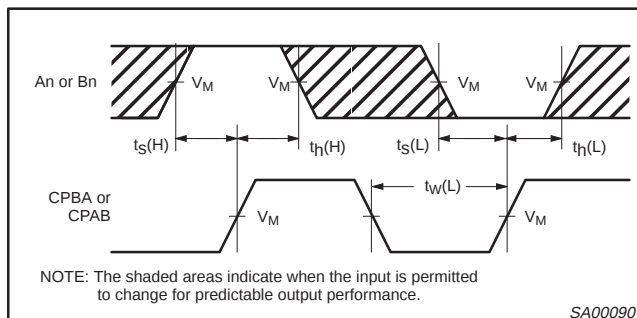
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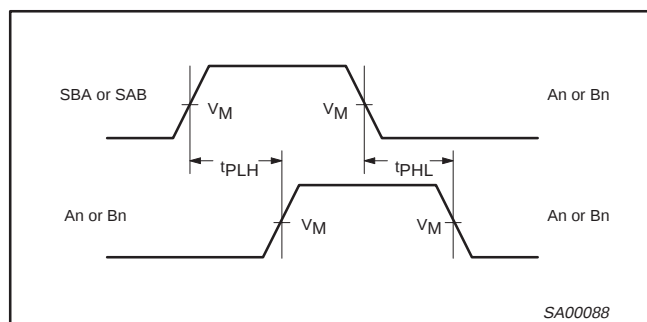
AC WAVEFORMS

 $V_M = 1.5V$, $V_{IN} = GND$ to $3.0V$ 

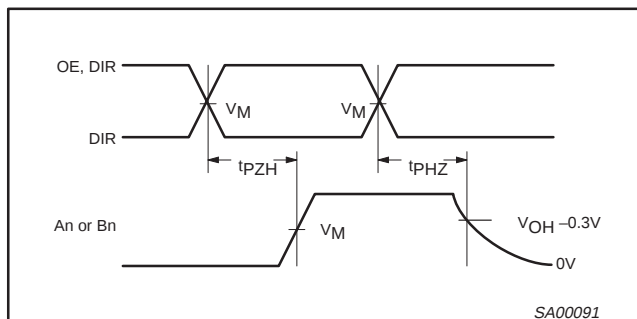
Waveform 1. Propagation Delay, Clock Input to Output, Clock Pulse Width, and Maximum Clock Frequency



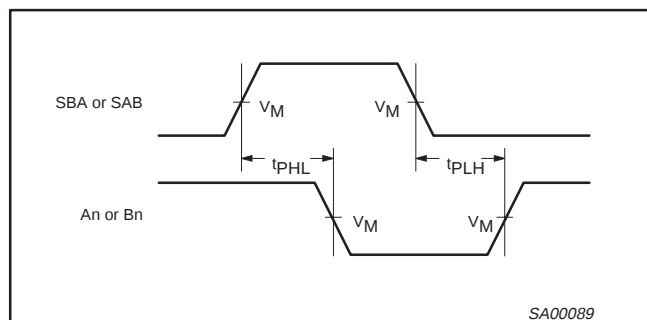
Waveform 4. Data Setup and Hold Times



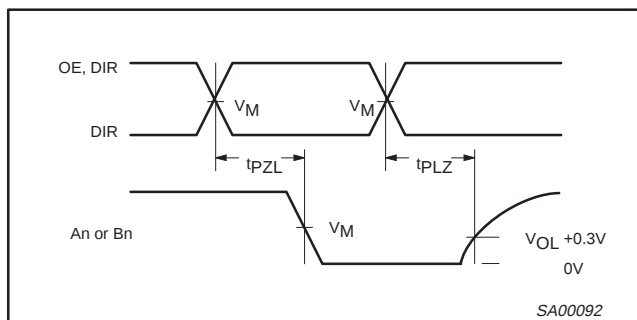
Waveform 2. Propagation Delay, SAB to Bn or SBA to An, An to Bn or Bn to An



Waveform 5. 3-State Output Enable Time to High Level and Output Disable Time from High Level



Waveform 3. Propagation Delay, SBA to An or SAB to Bn

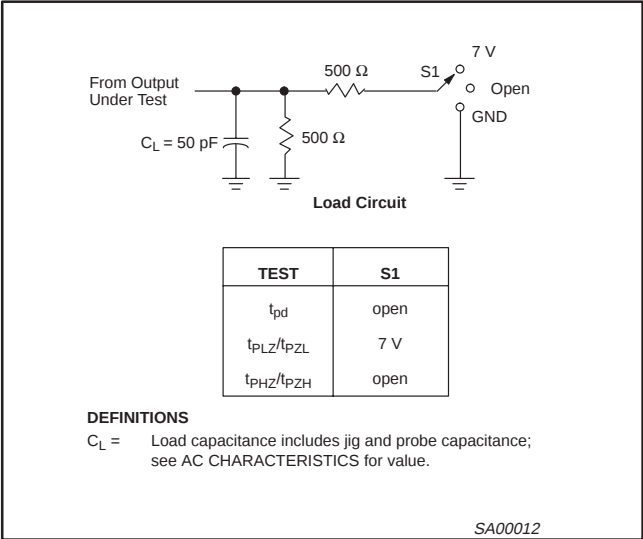


Waveform 6. 3-State Output Enable Time to Low Level and Output Disable Time from Low Level

Octal bus transceiver/register (3-State)

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TEST CIRCUIT AND WAVEFORM

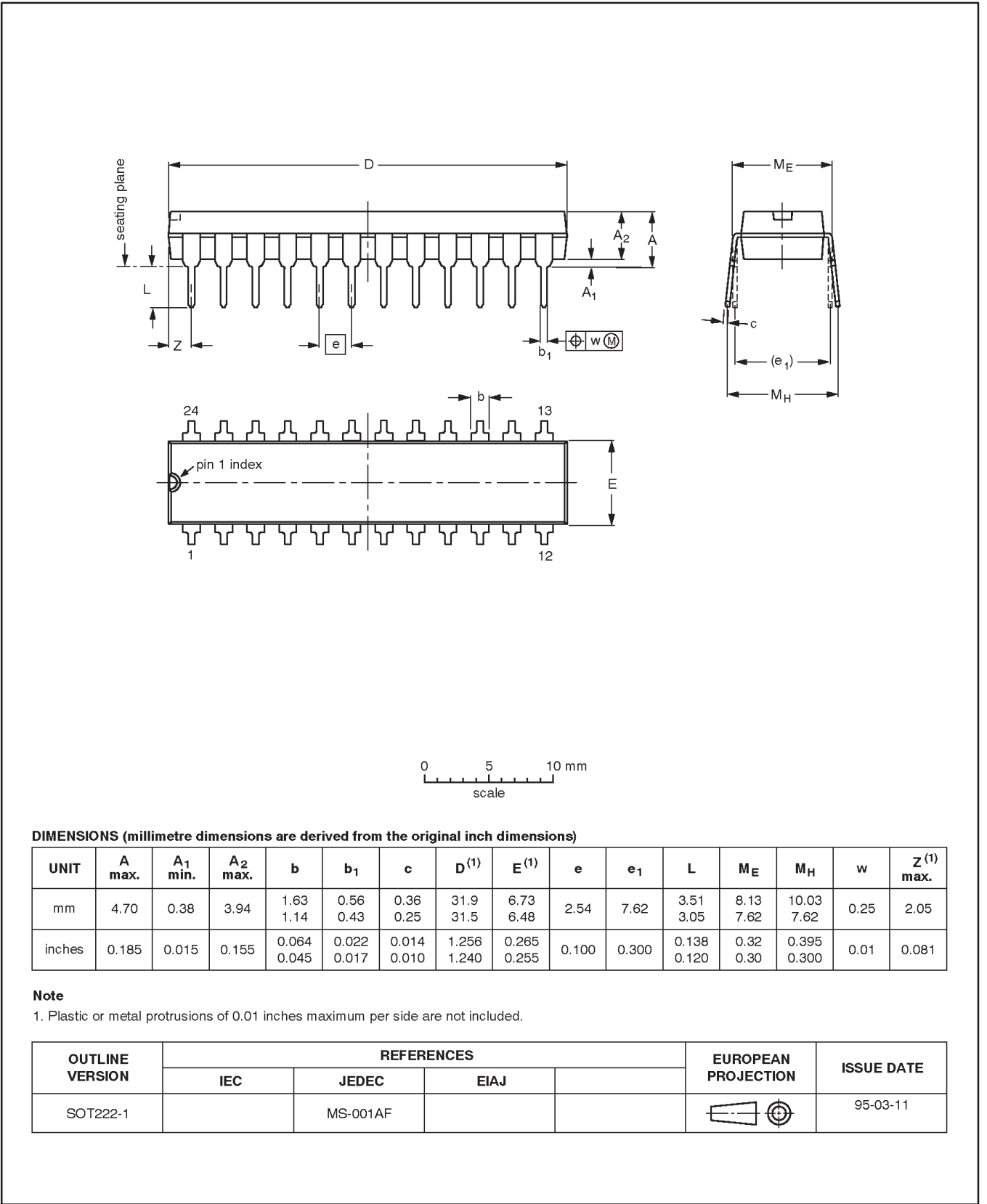


Octal bus transceiver/register (3-State)

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DIP24: plastic dual in-line package; 24 leads (300 mil)

SOT222-1

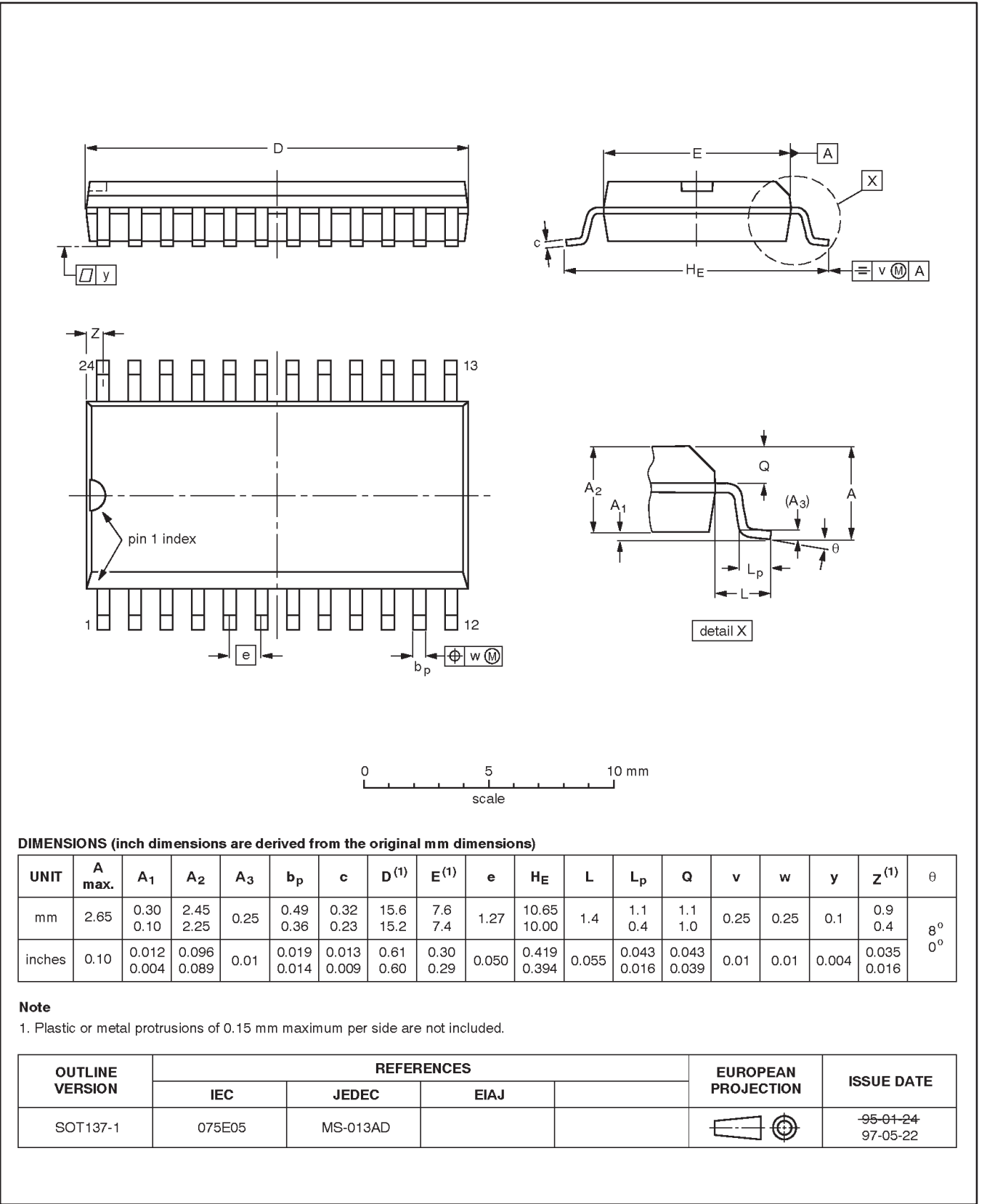


Octal bus transceiver/register (3-State)

74ABT646A

SO24: plastic small outline package; 24 leads; body width 7.5 mm

SOT137-1

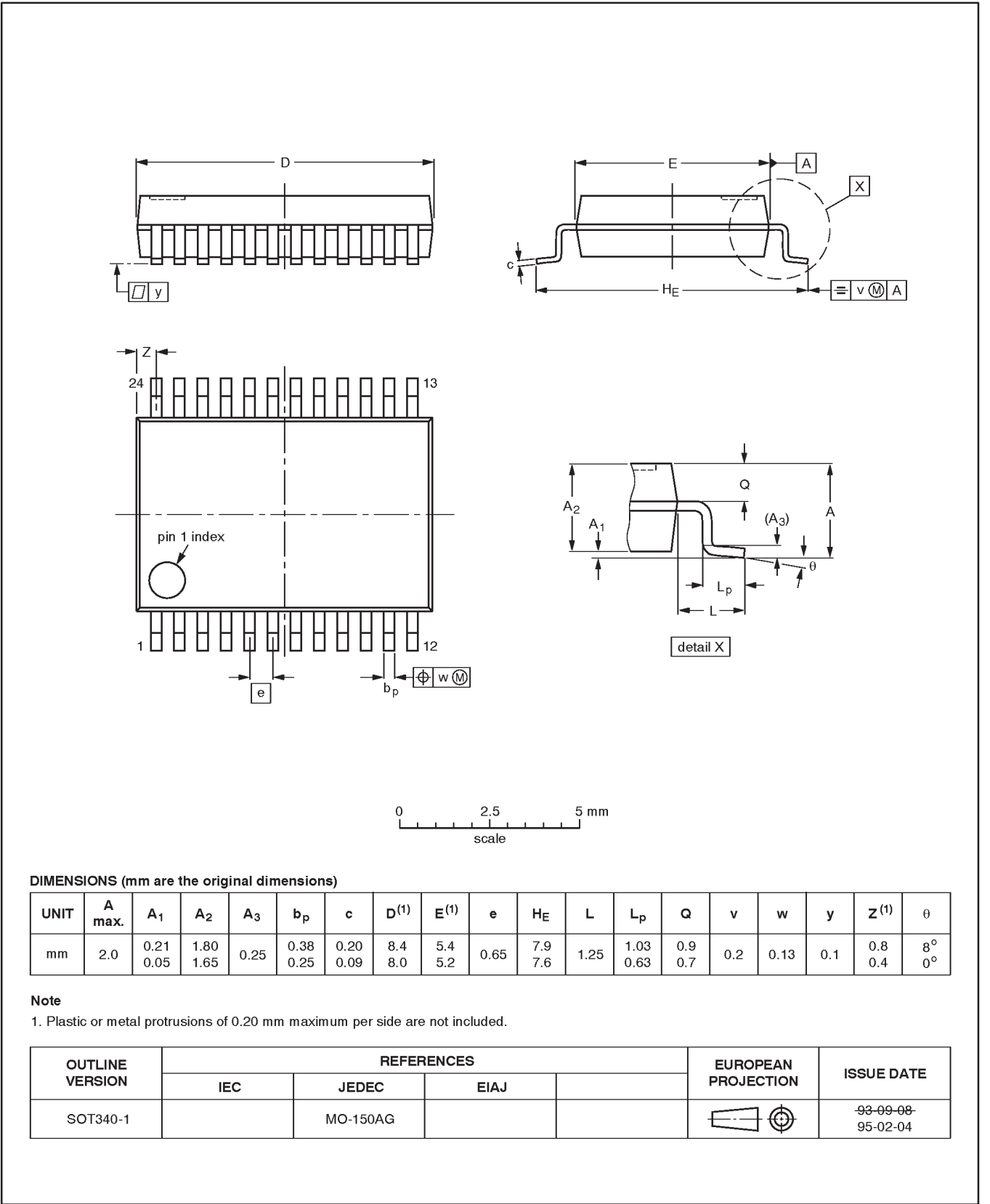


Octal bus transceiver/register (3-State)

74ABT646A

SSOP24: plastic shrink small outline package; 24 leads; body width 5.3 mm

SOT340-1

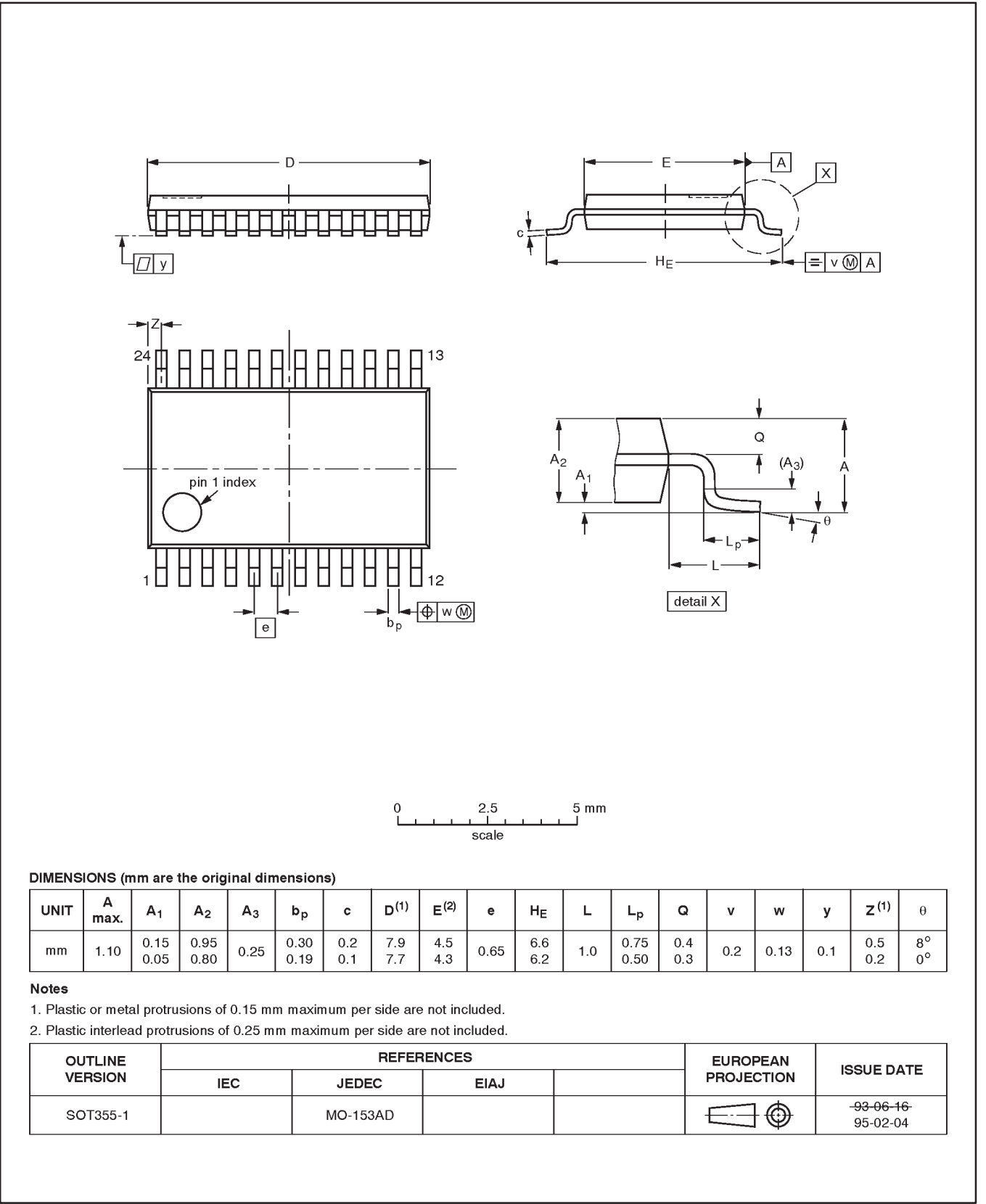


Octal bus transceiver/register (3-State)

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TSSOP24: plastic thin shrink small outline package; 24 leads; body width 4.4 mm

SOT355-1



Octal bus transceiver/register (3-State)

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Data sheet status

Data sheet status	Product status	Definition [1]
Objective specification	Development	This data sheet contains the design target or goal specifications for product development. Specification may change in any manner without notice.
Preliminary specification	Qualification	This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.
Product specification	Production	This data sheet contains final specifications. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.

[1] Please consult the most recently issued datasheet before initiating or completing a design.

Definitions

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Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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